PATENT

IE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kumar et al.

09/903,114 Serial No.

Filed:

July 11, 2001

For:

THERMAL PROCESSING SYSTEM

AND METHODS FOR FORMING LOW-K DIELECTRIC FILMS

SUITABLE FOR INCORPORATION

INTO MICROELECTRONIC DEVICES

Examiner:

B. Talbot

Group Art Unit: 1762

Docket No.

FSI0006/US/2

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 I CERTIFY THAT ON \ BEING DEPOSITED WITH THE U.S. POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO MAIL STOP NON-FEE AMENDMENT, MAIL STOP ISSUE FEE, COMMISSIONER FOR PATENTS, P.O. Box 1450, ALEXANDRIA, VA 22313-1450

PAULA J. BREEDEN

AMENDMENT AFTER ALLOWANCE UNDER 37 CFR 1.312

Dear Sir or Madam:

This Amendment is filed pursuant to 37 C.F.R. § 1.312 since it is filed after the mailing of the Notice of Allowance for the above-referenced Patent Application, which was mailed January 8, 2004.

This Amendment is believed to be timely because it is filed before the payment of the issue fee.

It is believed that no fee is required in filing this Amendment. However, if any fee is required, please charge the appropriate fee to the Kagan Binder Deposit Account No. 50-1775 and notify us of the same.